

5-102570-6 ✓ ACTIVE

AMPMODU | AMPMODU Headers

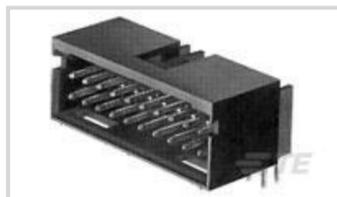
TE Internal #: 5-102570-6

PCB Mount Header, Right Angle, Wire-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: **Wire-to-Board**

Number of Positions: **16**

Number of Rows: **2**

Centerline (Pitch): **2.54 mm [.1 in]**

PCB Mount Orientation: **Right Angle**

## Features

### Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header

### Configuration Features

Connector Contact Load Condition	Fully Loaded
Number of Positions	16
Number of Rows	2
PCB Mount Orientation	Right Angle

### Electrical Characteristics

Insulation Resistance	5000 M $\Omega$
Dielectric Withstanding Voltage (Max)	750 Vrms

### Body Features

Connector Profile	Standard
Primary Product Color	Black

### Contact Features

Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 $\mu$ m[100 – 200 $\mu$ in]



Contact Mating Area Plating Material Thickness	.381 $\mu\text{m}$ [15 $\mu\text{in}$ ]
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	3 A

### Termination Features

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.43 mm[.135 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

### Mechanical Attachment

Mating Alignment Type	Polarization
Mating Retention	With
Mating Retention Type	Detent Window
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without

### Housing Features

Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]

### Dimensions

PCB Thickness (Recommended)	1.4 mm[.055 in]
Row-to-Row Spacing	2.54 mm[.1 in]

### Usage Conditions

Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 $^{\circ}\text{C}$ [-85 – 221 $^{\circ}\text{F}$ ]

### Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal



### Industry Standards

Agency/Standard	CSA
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0

### Packaging Features

Packaging Quantity	176
Packaging Type	Tray

### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 240°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

### Compatible Parts



TE Part # 1-86177-5  
16 MODIV HSG COMP DR .100CL



TE Part # 87977-6  
16 MODIV HSG DR MRKD .100 POL



TE Part # 1-87456-1  
16 MODIV HSG COMP DR .100CL

## Also in the Series | AMPMODU Headers



PCB Connector Mounting(1)



PCB Connector Shrouds(1)



PCB Headers & Receptacles(6830)



PCB Latches, Locks & Retainers(2)



Wire-to-Board Connector Assemblies  
& Housings(5)



Wire-to-Board Connector Contacts(66)

## Documents

### Product Drawings

16 MODII HDR DRRR SHRD LF

English

### CAD Files

3D PDF

English

Customer View Model

[ENG\\_CVM\\_5-102570-6\\_H.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_5-102570-6\\_H.3d\\_stp.zip](#)

English

Customer View Model

[ENG\\_CVM\\_5-102570-6\\_H.2d\\_dxf.zip](#)

English

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PCB Mount Header, Right Angle, Wire-to-Board, 16 Position, 2.54 mm [.1 in]  
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## Datasheets & Catalog Pages

[AMPMODU\\_INTERCONNECTION\\_SYSTEM\\_SECTION5](#)

English